





Welcome to **E-XFL.COM** 

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded - Microcontrollers</u>"

Details	
Product Status	Obsolete
Core Processor	FR81S
Core Size	32-Bit Single-Core
Speed	80MHz
Connectivity	CANbus, CSIO, I <sup>2</sup> C, LINbus, SPI, UART/USART
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	76
Program Memory Size	320KB (320K x 8)
Program Memory Type	FLASH
EEPROM Size	64K x 8
RAM Size	56K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 37x12b; D/A 2x8b
Oscillator Type	External
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	100-LQFP
Supplier Device Package	100-LQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/mb91f522fwcpmc-gte2



Table for clock supervisor and external low voltage detection reset initial value ON/OFF

Clock	CSV Initial value	LVD Initial value	Function
	ON	ON	S
a in alla	ON	OFF	U
single	055	ON	Н
	OFF	OFF	K
	ON	ON	W
Dest	ON	OFF	Y
Dual	055	ON	J
	OFF	OFF	L



### ■ Storage of Semiconductor Devices

Because plastic chip packages are formed from plastic resins, exposure to natural environmental conditions will cause absorption of moisture. During mounting, the application of heat to a package that has absorbed moisture can cause surfaces to peel, reducing moisture resistance and causing packages to crack. To prevent, do the following:

- (1) Avoid exposure to rapid temperature changes, which cause moisture to condense inside the product. Store products in locations where temperature changes are slight.
- (2) Use dry boxes for product storage. Products should be stored below 70% relative humidity, and at temperatures between 5°C and 30°C.
  - When you open Dry Package that recommends humidity 40% to 70% relative humidity.
- (3) When necessary, Cypress packages semiconductor devices in highly moisture-resistant aluminum laminate bags, with a silica gel desiccant. Devices should be sealed in their aluminum laminate bags for storage.
- (4) Avoid storing packages where they are exposed to corrosive gases or high levels of dust.

#### ■ Baking

Packages that have absorbed moisture may be de-moisturized by baking (heat drying). Follow the Cypress recommended conditions for baking.

Condition: 125°C/24 h

### ■ Static Electricity

Because semiconductor devices are particularly susceptible to damage by static electricity, you must take the following precautions:

- (1) Maintain relative humidity in the working environment between 40% and 70%. Use of an apparatus for ion generation may be needed to remove electricity.
- (2) Electrically ground all conveyors, solder vessels, soldering irons and peripheral equipment.
- (3) Eliminate static body electricity by the use of rings or bracelets connected to ground through high resistance (on the level of 1 MΩ).
  - Wearing of conductive clothing and shoes, use of conductive floor mats and other measures to minimize shock loads is recommended.
- (4) Ground all fixtures and instruments, or protect with anti-static measures.
- (5) Avoid the use of styrofoam or other highly static-prone materials for storage of completed board assemblies.
- 3. Precautions for Use Environment

Reliability of semiconductor devices depends on ambient temperature and other conditions as described above.

For reliable performance, do the following:

#### (1) Humidity

Prolonged use in high humidity can lead to leakage in devices as well as printed circuit boards. If high humidity levels are anticipated, consider anti-humidity processing.

(2) Discharge of Static Electricity

When high-voltage charges exist close to semiconductor devices, discharges can cause abnormal operation. In such cases, use anti-static measures or processing to prevent discharges.

(3) Corrosive Gases, Dust, or Oil

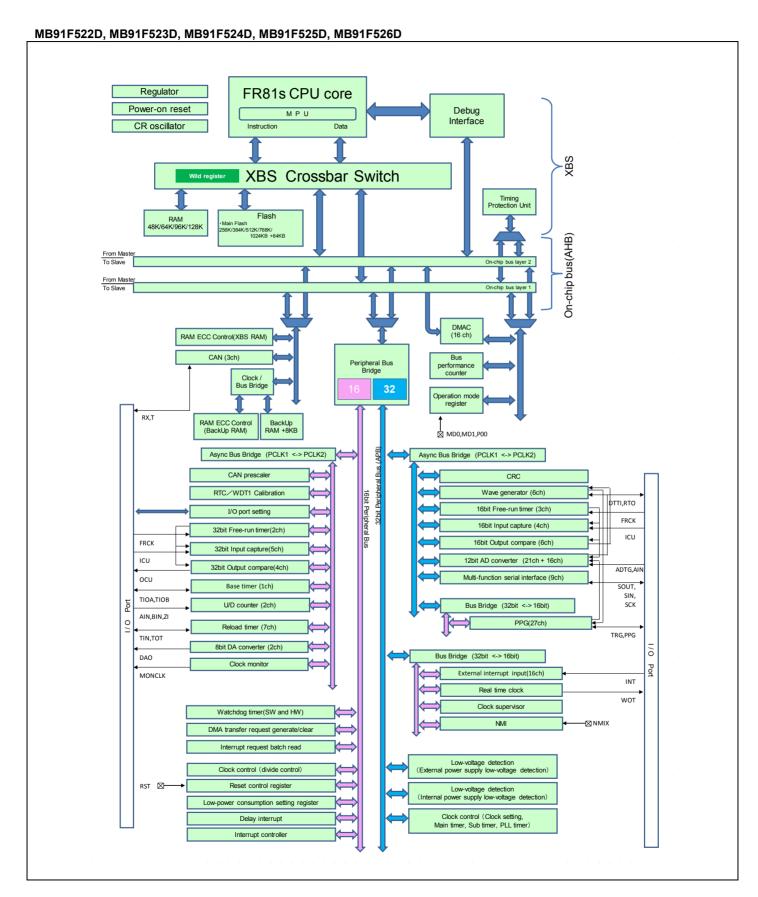
Exposure to corrosive gases or contact with dust or oil may lead to chemical reactions that will adversely affect the device. If you use devices in such conditions, consider ways to prevent such exposure or to protect the devices.

(4) Radiation, Including Cosmic Radiation

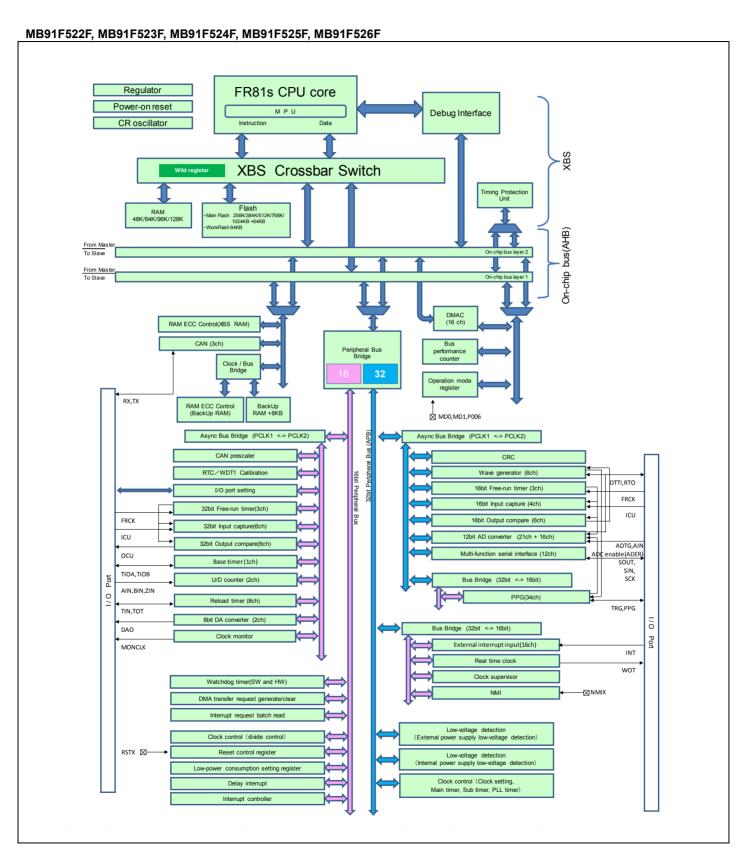
Most devices are not designed for environments involving exposure to radiation or cosmic radiation. Users should provide shielding as appropriate.

Document Number: 002-04662 Rev. \*D











### MB91F522J, MB91F523J, MB91F524J, MB91F525J, MB91F526J Regulator FR81s CPU core Power-on reset MPU Debug Interface CR oscillator Instruction Data XBS XBS Crossbar Switch Flash On-chip bus(AHB) From Maste To Slave From Maste RAM ECC Control(XBS RAM) CAN (3ch) RX,TX RAM ECC Control (BackUp RAM) Async Bus Bridge (PCLK1 <-> PCLK2) Async Bus Bridge (PCLK1 <-> PCLK2) CAN prescaler CRC RTC/WDT1 Calibration DTTI.RTO 16bit Free-run timer (3ch) I/O port setting FRCK 16bit Input capture (4ch) 32bit Free-run timer(3ch) FRCK 16bit Output compare (6ch) 32bit Input capture(6ch) 12bit AD converter (26ch + 16ch) ICU 32bit Output compare(6ch) ADTG AIR enable(ADER) SOUT, OCU Base timer (2ch) TIOA,TIOB Bus Bridge (32bit <-> 16bit) U/D counter (2ch) AIN,BIN,ZIN Reload timer (8ch) TRG,PPG TIN,TOT 8bit DA converter (2ch DAO Bus Bridge (32bit <-> 16bit) Clock monitor External interrupt input (16ch) MONCLK Real time clock Watchdog timer(SW and HW) ⊠NMIX NMI DMA transfer request generate/cle Low-voltage detection (External power supply low-voltage detection) Clock control (divide control RSTX ⊠ Reset control register (Internal power supply low-voltage detection) Low-power consumption setting register Clock control (Clock setting, Main timer, Sub timer, PLL time Delay interrupt Interrupt controlle



		Address offset val	ue / Register name		<b>D</b> 11			
Address -	+0	Block						
000120 <sub>н</sub>	OCCP6 [R/W] W 00000000 00000000 00000000							
000124 <sub>н</sub>		Output Compare 6,7						
000128 <sub>Н</sub>	_	32-bit OCU						
00012С <sub>Н</sub>		OCCP8 00000000 00000000	[R/W] W 00000000 00000000					
000130н			[R/W] W 00000000 00000000		Output Compare 8,9 32-bit OCU			
000134н	_	_	OCSH89 [R/W] B,H,W 000	OCSL89 [R/W] B,H,W 000000				
000138 <sub>H</sub> to	<del></del>	_	_	_	Reserved			
0001В4 <sub>Н</sub> 0001В8 <sub>Н</sub>	EPFR64 [R/W] B,H,W 00-	EPFR65 [R/W] B,H,W 0000-000	EPFR66 [R/W] B,H,W 000000	EPFR67 [R/W] B,H,W 0000				
0001BС <sub>н</sub>	EPFR68 [R/W] B,H,W 0000	EPFR69 [R/W] B,H,W 0000	EPFR70 [R/W] B,H,W 00000	EPFR71 [R/W] B,H,W -0-0-0-0				
0001C0 <sub>н</sub>	EPFR72 [R/W] B,H,W 000000-0	EPFR73 [R/W] B,H,W 00000000	EPFR74 [R/W] B,H,W 00000000	EPFR75 [R/W] B,H,W 00000000				
0001С4н	EPFR76 [R/W] B,H,W 00000000	EPFR77 [R/W] B,H,W 000000	EPFR78 [R/W] B,H,W 00	EPFR79 [R/W] B,H,W 00000000	Extended port function register			
0001С8 <sub>н</sub>	EPFR80 [R/W] B,H,W 00000	EPFR81 [R/W] B,H,W 00000000	EPFR82 [R/W] B,H,W 00000000	EPFR83 [R/W] B,H,W -0000000				
0001СС <sub>н</sub>	EPFR84 [R/W] B,H,W 00000000	EPFR85 [R/W] B,H,W 000000	EPFR86 [R/W] B,H,W 00000	EPFR87 [R/W] B,H,W 00				
0001D0 <sub>н</sub>	EPFR88 [R/W] B,H,W 0	_	_	_				
0001D4 <sub>н</sub>	_	_	_	_	Reserved			
0001D8 <sub>H</sub>		4 [R/W] H XXXXXXXX		[R] H XXXXXXXX	- Reload Timer 4			
0001DC <sub>н</sub>		4 [R/W] H XXXXXXXX	TMCSR4 [F 00000000	Reload Timer 4				
0001E0 <sub>H</sub> to 0001EC <sub>H</sub>	_	_			Reserved			
0001F0 <sub>н</sub>		5 [R/W] H XXXXXXXX		[R] H XXXXXXXX	Polond Times 5			
0001F4 <sub>Н</sub>		5 [R/W] H XXXXXXXX		R/W] B, H,W 0-000000	Reload Timer 5			



Addoss	Address offset value / Register name								
Address	+0	+1	+2	+2 +3					
000328 <sub>H</sub>	DEAR [R] W XXXXXXXX XXXXXXXX XXXXXXXX								
00032С <sub>н</sub>	_	_		DESR [R/W] H 000000					
000330н	PABR0 [R/W] W XXXXXXXX XXXXXXXX XXXXXXX								
000334н	_	_		[R/W] H 0 000000	can access this area)				
000338н	)	PABR1	[R/W] W X XXXXXXXX XXXX00	000					
00033Сн	_	_		[R/W] H 0 000000					
000340н	)	PABR2	[R/W] W X XXXXXXXX XXXX00	000					
000344н	_	_		[R/W] H 0 000000					
000348н	)	PABR3	[R/W] W X XXXXXXXX XXXX00	000					
00034Сн	_	_		[R/W] H					
000350н	,	PABR4	[R/W] W X XXXXXXXX XXXX00	000					
000354н	_	_		[R/W] H	MPU [S] (Only CPU core				
000358н	)	PABR5	[R/W] W X XXXXXXXX XXXX00	000	can access this area)				
00035С <sub>Н</sub>	_	_		[R/W] H 0 000000					
000360н	)	PABR6	[R/W] W X XXXXXXX XXXX00	000					
000364н	_	_		[R/W] H 0 000000					
000368н	,	PABR7	[R/W] W X XXXXXXXX XXXX00	000					
00036Сн	_	_							
000370 <sub>Н</sub> to 0003AC <sub>Н</sub>		1	_						
0003B0 <sub>H</sub> to 0003FC <sub>H</sub>	_	_	_	_	Reserved [S]				



۰ ماما		Address offset val	ue / Register name		Diesis
Address	+0	+1	+2	+3	Block
000440 <sub>H</sub>	ICR00 [R/W] B,H,W	ICR01 [R/W] B,H,W	ICR02 [R/W] B,H,W	ICR03 [R/W] B,H,W	
000444 <sub>H</sub>	ICR04 [R/W] B,H,W 11111	ICR05 [R/W] B,H,W 11111	ICR06 [R/W] B,H,W 11111	ICR07 [R/W] B,H,W 11111	
000448 <sub>H</sub>	ICR08 [R/W] B,H,W 11111	ICR09 [R/W] B,H,W 11111	ICR10 [R/W] B,H,W 11111	ICR11 [R/W] B,H,W 11111	
00044С <sub>н</sub>	ICR12 [R/W] B,H,W 11111	ICR13 [R/W] B,H,W 11111	ICR14 [R/W] B,H,W 11111	ICR15 [R/W] B,H,W 11111	
000450 <sub>н</sub>	ICR16 [R/W] B,H,W 11111	ICR17 [R/W] B,H,W 11111	ICR18 [R/W] B,H,W 11111	ICR19 [R/W] B,H,W 11111	
000454 <sub>Н</sub>	ICR20 [R/W] B,H,W 11111	ICR21 [R/W] B,H,W 11111	ICR22 [R/W] B,H,W 11111	ICR23 [R/W] B,H,W 11111	Interrupt
000458 <sub>н</sub>	ICR24 [R/W] B,H,W 11111	ICR25 [R/W] B,H,W 11111	ICR26 [R/W] B,H,W 11111	ICR27 [R/W] B,H,W 11111	Controller [S]
00045С <sub>н</sub>	ICR28 [R/W] B,H,W 11111	ICR29 [R/W] B,H,W 11111	ICR30 [R/W] B,H,W	ICR31 [R/W] B,H,W 11111	
000460 <sub>H</sub>	ICR32 [R/W] B,H,W 11111	ICR33 [R/W] B,H,W	ICR34 [R/W] B,H,W	ICR35 [R/W] B,H,W 11111	
000464н	ICR36 [R/W] B,H,W	ICR37 [R/W] B,H,W	ICR38 [R/W] B,H,W	ICR39 [R/W] B,H,W 11111	
000468 <sub>H</sub>	ICR40 [R/W] B,H,W 11111	ICR41 [R/W] B,H,W	ICR42 [R/W] B,H,W	ICR43 [R/W] B,H,W 11111	
00046С <sub>н</sub>	ICR44 [R/W] B,H,W 11111	ICR45 [R/W] B,H,W	ICR46 [R/W] B,H,W	ICR47 [R/W] B,H,W 11111	
000470 <sub>H</sub> to 00047C <sub>H</sub>	_	_	_	_	Reserved [S]
000480н	RSTRR [R] B,H,W XXXXXX	RSTCR [R/W] B,H,W 1110	STBCR [R/W] B,H,W * 00011		Reset Control [S] Power Control [S] *: Writing STBCR by DMA is forbidden
000484н	_	_	_	_	Reserved [S]
000488 <sub>H</sub>	DIVR0 [R/W] B,H,W 000	DIVR1 [R/W] B,H,W 0001	DIVR2 [R/W] B,H,W 0011	_	Clock Control [S]
00048C <sub>H</sub>	_	_	_		Reserved [S]
000490 <sub>H</sub>	IORR0 [R/W] B,H,W -0000000	IORR1 [R/W] B,H,W -0000000	IORR2 [R/W] B,H,W -0000000	IORR3 [R/W] B,H,W -0000000	
000494 <sub>н</sub>	IORR4 [R/W] B,H,W -0000000	IORR5 [R/W] B,H,W -0000000	IORR6 [R/W] B,H,W -0000000	IORR7 [R/W] B,H,W -0000000	DMA request by peripheral [S]
000498 <sub>H</sub>	IORR8 [R/W] B,H,W -0000000	IORR9 [R/W] B,H,W -0000000	IORR10 [R/W] B,H,W -0000000	IORR11 [R/W] B,H,W -0000000	



A state		Address offset va	lue / Register name		Block		
Address	+0	+0 +1 +2 +3					
0012D4 <sub>Н</sub>		16-bit Free-run timer selection					
0012D8 <sub>н</sub>			W] B,H,W )00000000		A/D activation compare		
0012DC <sub>H</sub> to 0012FC <sub>H</sub>	_	_	_	_	Reserved		
001300 <sub>н</sub>		-	_		Reserved		
001304н	ADTSS0[R/W] B,H,W 0	_	_	_	12-bit A/D		
001308 <sub>Н</sub>		-	R/W] B,H,W 0 00000000 00000000		converter 1/2 unit		
00130Сн		OMPB0[R/W] H,W 00000000		ADCOMP1/ADCOMPB1[R/W] H,W 00000000 00000000			
001310н		ADCOMP2/ADCOMPB2[R/W] H,W 00000000 00000000 ADCOMP4/ADCOMPB4[R/W] H,W 00000000 00000000		OMPB3[R/W] H,W 00000000			
001314н				ADCOMP5/ADCOMPB5[R/W] H,W 00000000 00000000 ADCOMP7/ADCOMPB7[R/W] H,W 00000000 00000000			
001318н							
00131Сн		OMPB8[R/W] H,W 00000000		OMPB9[R/W] H,W 00000000			
001320н		OMPB10[R/W] H,W 00000000		OMPB11[R/W] H,W 00000000			
001324н		OMPB12[R/W] H,W 00000000		OMPB13[R/W] H,W 00000000	12-bit A/D		
001328н		OMPB14[R/W] H,W 00000000		OMPB15[R/W] H,W 00000000	converter 1/2 unit		
00132Сн		OMPB16[R/W] H,W 00000000		OMPB17[R/W] H,W 00000000			
001330н	ADCOMP18/ADC0 00000000	OMPB18[R/W] H,W 00000000		OMPB19[R/W] H,W 00000000			
001334н		OMPB20[R/W] H,W 00000000	ADCOMP21/ADC0 00000000				
001338н	ADCOMP22/ADC0 00000000	OMPB22[R/W] H,W 00000000		OMPB23[R/W] H,W 00000000			
00133Сн		OMPB24[R/W] H,W 00000000		OMPB25[R/W] H,W 00000000			
001340н		OMPB26[R/W] H,W 00000000		OMPB27[R/W] H,W 00000000			



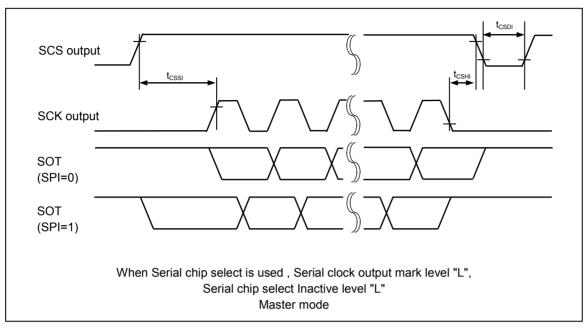
80 pins

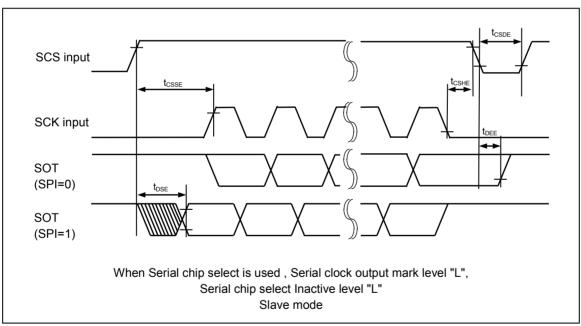
	Interrupt		Interrupt		Default	
Interrupt factor	Decimal	Hexa decimal	level	Offset	address for TBR	RN
Reset	0	0	-	3FC <sub>H</sub>	000FFFC <sub>н</sub>	ı
System reserved	1	1	-	3F8 <sub>H</sub>	000FFFF8 <sub>H</sub>	-
System reserved	2	2	-	3F4 <sub>H</sub>	000FFFF4 <sub>H</sub>	ı
System reserved	3	3	-	3F0 <sub>H</sub>	000FFFF0 <sub>н</sub>	-
System reserved	4	4	-	3EC <sub>H</sub>	000FFFEC <sub>H</sub>	-
FPU exception	5	5	-	3E8 <sub>H</sub>	000FFFE8 <sub>H</sub>	-
Exception of instruction access protection violation	6	6	-	3E4 <sub>H</sub>	000FFFE4 <sub>н</sub>	-
Exception of data access protection violation	7	7	-	3E0 <sub>H</sub>	000FFFE0 <sub>H</sub>	-
Data access error interrupt	8	8	-	3DC <sub>H</sub>	000FFFDC <sub>H</sub>	ı
INTE instruction	9	9	-	3D8 <sub>H</sub>	000FFFD8 <sub>H</sub>	ı
Instruction break	10	0A	-	3D4 <sub>H</sub>	000FFFD4 <sub>H</sub>	-
System reserved	11	0B	-	3D0 <sub>H</sub>	000FFFD0 <sub>н</sub>	ı
System reserved	12	0C	-	3ССн	000FFFCC <sub>H</sub>	ı
System reserved	13	0D	-	3C8 <sub>H</sub>	000FFFC8 <sub>H</sub>	_
Exception of invalid instruction	14	0E	-	3C4 <sub>H</sub>	000FFFC4 <sub>H</sub>	ı
NMI request						
Error generation during internal bus diagnosis			45 (5 )			
XBS RAM double-bit error generation	15	0F	15 (F <sub>H</sub> )	3С0н	000FFFC0 <sub>н</sub>	-
Backup RAM double-bit error generation	1		Fixed			
TPU violation	1					
External interrupt 0-7	16	10	ICR00	3ВСн	000FFFBC <sub>H</sub>	0
External interrupt 8-15						1* <sup>7</sup>
External low-voltage detection interrupt	17	11	ICR01	3B8 <sub>H</sub>	000FFFB8 <sub>H</sub>	1*
Reload timer 0/1/4/5	18	12	ICR02	3B4 <sub>H</sub>	000FFFB4 <sub>н</sub>	2* <sup>2</sup>
Reload timer 3/6/7	19	13	ICR03	3B0 <sub>H</sub>	000FFFB0 <sub>H</sub>	3* <sup>2</sup>
Multi-function serial interface						
ch <sub>.</sub> 0 (reception completed)	20	4.4	ICD04	240	00055540	4* <sup>1</sup>
Multi-function serial interface	20	14	ICR04	3AC <sub>H</sub>	000FFFAC <sub>H</sub>	4"
ch <sub>.</sub> 0 (status)						
Multi-function serial interface	21	15	ICDOE	240	0005554.0	5* <sup>1</sup>
ch 0 (transmission completed)	21	15	ICR05	3A8 <sub>H</sub>	000FFFA8 <sub>H</sub>	_
-	22	16	ICR06	3A4 <sub>H</sub>	000FFFA4 <sub>н</sub>	_* <sup>6</sup>
-	23	17	ICR07	3A0 <sub>H</sub>	000FFFA0 <sub>H</sub>	-* <sup>6</sup>
Multi-function serial interface						
ch_2 (reception completed)	24	18	ICR08	39Сн	000FFF9С <sub>н</sub>	8* <sup>1</sup>
Multi-function serial interface	24	10	ICKUO	39CH	000FFF9CH	0
ch 2 (status)						
Multi-function serial interface	25	19	ICR09	398н	000FFF98 <sub>н</sub>	9* <sup>1</sup>
ch 2 (transmission completed)	20	19	101108	OGOH	00011130H	9
Multi-function serial interface						
ch 3 (reception completed)	26	1A	ICR10	394 <sub>H</sub>	000FFF94 <sub>н</sub>	10* <sup>1</sup>
Multi-function serial interface	20	'^	101(10	OOTH	3001113 <del>1</del> H	10
ch 3 (status)						
Multi-function serial interface	27	1B	ICR11	390 <sub>H</sub>	000FFF90 <sub>H</sub>	11
ch 3 (transmission completed)		'0	.5	JJJH	OCCITION H	



120 pins	Interr	upt number	Interrupt		Default			
Interrupt factor	Decimal	Hexadecimal	level	Offset	address for TBR	RN		
Reset	0	0	-	3FC <sub>H</sub>	000FFFFC <sub>H</sub>	-		
System reserved	1	1	-	3F8 <sub>H</sub>	000FFFF8 <sub>H</sub>	-		
System reserved	2	2	-	3F4 <sub>H</sub>	000FFFF4 <sub>H</sub>	-		
System reserved	3	3	-	3F0 <sub>H</sub>	000FFFF0 <sub>H</sub>	-		
System reserved	4	4	-	3ЕСн	000FFFEC <sub>н</sub>	-		
FPU exception	5	5	-	3E8 <sub>H</sub>	000FFFE8 <sub>H</sub>	-		
Exception of instruction access protection violation	6	6	_	3E4 <sub>H</sub>	000FFFE4 <sub>H</sub>	_		
Exception of data access protection violation	7	7	_	3E0 <sub>H</sub>	000FFFE0 <sub>H</sub>	-		
Data access error interrupt	8	8	-		000FFFDC <sub>H</sub>	-		
INTE instruction	9	9	-		000FFFD8 <sub>H</sub>	-		
Instruction break	10	0A	-		000FFFD4 <sub>H</sub>	-		
System reserved	11	0B	-		000FFFD0 <sub>H</sub>	_		
System reserved	12	0C	_		000FFFCC <sub>H</sub>	_		
System reserved	13	0D	_		000FFFC8 <sub>H</sub>	-		
Exception of invalid instruction	14	0E	_		000FFFC4 <sub>H</sub>	_		
NMI request		02		00 ін	000111016			
Error generation during internal bus diagnosis								
XBS RAM double-bit error generation	15	0F	15 (F <sub>H</sub> )	3C0 <sub>H</sub>	000FFFC0 <sub>H</sub>	_		
Backup RAM double-bit error generation	13	OI	Fixed	JCOH	OOOI I I COH	_		
TPU violation								
External interrupt 0-7	16	10	ICR00	2DC	000FFFBC <sub>H</sub>	0		
External interrupt 8-15	10	10	ICKUU	SBCH	OUOFFFBCH			
•	17	11	ICR01	3B8 <sub>H</sub>	000FFFB8 <sub>H</sub>	1*		
External low-voltage detection interrupt	18	12	ICR02	204	000FFFB4 <sub>H</sub>	2*		
Reload timer 0/1/4/5						3*		
Reload timer 2/3/6/7	19	13	ICR03	3B0 <sub>H</sub>	000FFFB0 <sub>H</sub>	3"		
Multi-function serial interface								
ch.0 (reception completed)	20	20	20	14	ICR04	3АСн	000FFFAC <sub>H</sub>	4*
Multi-function serial interface								
ch.0 (status)								
Multi-function serial interface	21	15	ICR05	3A8 <sub>H</sub>	000FFFA8 <sub>н</sub>	5*		
ch.0 (transmission completed)								
Multi-function serial interface								
ch.1 (reception completed)	22	16	ICR06	3A4 <sub>H</sub>	000FFFA4 <sub>н</sub>	6*		
Multi-function serial interface								
ch.1 (status)								
Multi-function serial interface	23	17	ICR07	3A0 <sub>H</sub>	000FFFA0 <sub>н</sub>	7*		
ch.1 (transmission completed)  Multi-function serial interface								
ch.2 (reception completed)								
· · · · · · · · · · · · · · · · · · ·	24	18	ICR08	39Сн	000FFF9С <sub>н</sub>	8*		
Multi-function serial interface								
ch.2 (status)  Multi-function serial interface	1		<del>                                     </del>					
	25	19	ICR09	398н	000FFF98 <sub>н</sub>	9*		
ch.2 (transmission completed)								
Multi-function serial interface								
ch.3 (reception completed)	26	1A	ICR10	394 <sub>H</sub>	000FFF94 <sub>н</sub>	10'		
Multi-function serial interface								
ch.3 (status)								









### Flash memory

(1) Electrical Characteristics

Doromotor	V	Value			Domonico
Parameter	Min	Тур	Max	Unit	Remarks
	-	200	800	ms	8 Kbytes sector* <sup>1</sup> , excluding internal preprogramming time
0	_	300	1100	ms	8 Kbytes sector* <sup>1</sup> , including internal preprogramming time
Sector erase time	_	400	2000	ms	64 Kbytes sector* <sup>1</sup> , excluding internal preprogramming time
	_	700	3700	ms	64 Kbytes sector* <sup>1</sup> , including internal preprogramming time
8-bit writing time	-	9	288	μs	Exclusive of overhead time at system level*1
16-bit writing time	-	12	384	μs	Exclusive of overhead time at system level*1
ECC writing time	_	9	288	μs	Exclusive of overhead time at system level*1
Erase cycle*²/ Data retain time	1,000 cycles/ 20 years, 10,000 cycles/ 10 years, 100,000 cycles/ 5 years	-	_	_	Average T <sub>A</sub> =+85°C* <sup>3</sup>

<sup>\*1:</sup> The guaranteed value for erasure up to 100,000 cycles.

# (2) Notes

While the Flash memory is written or erased, shutdown of the external power (Vcc) is prohibited.

In the application system where Vcc might be shut down while writing or erasing, be sure to turn the power off by using an external voltage detection function.

To put it concretely, after the external power supply voltage falls below the detection voltage ( $V_{DL}^*$ ), hold Vcc at 2.7V or more within the duration calculated by the following expression:

$$Td^*[\mu s] + (period of PCLK [\mu s] \times 257) + 50 [\mu s]$$

Document Number: 002-04662 Rev. \*D

<sup>\*2:</sup> Number of erase cycles for each sector.

<sup>\*3:</sup> This value comes from the technology qualification (using Arrhenius equation to translate high temperature measurements into normalized value at + 85°C).

<sup>\*:</sup> See "4.AC Characteristics (8) Low-voltage detection (External low-voltage detection) "



# 15. Ordering Information MB91F52xxxD

Part number	Sub clock	CSV Initial value	LVD Initial value	Package*
MB91F526LWDPMC	Yes	ON	ON	
MB91F526LJDPMC		OFF	ON	
MB91F525LWDPMC		ON	ON	
MB91F525LJDPMC		OFF	ON	
MB91F524LWDPMC		ON	ON	
MB91F524LJDPMC		OFF	ON	
MB91F523LWDPMC		ON	ON	
MB91F523LJDPMC		OFF	ON	
MB91F522LWDPMC		ON	ON	
MB91F522LJDPMC		OFF	ON	LQP · 176 pin,
MB91F526LSDPMC	None	ON	ON	Plastic
MB91F526LHDPMC		OFF	ON	
MB91F525LSDPMC		ON	ON	
MB91F525LHDPMC		OFF	ON	
MB91F524LSDPMC		ON	ON	
MB91F524LHDPMC		OFF	ON	
MB91F523LSDPMC		ON	ON	
MB91F523LHDPMC		OFF	ON	
MB91F522LSDPMC		ON	ON	
MB91F522LHDPMC		OFF	ON	
MB91F526KWDPMC	Yes	ON	ON	
MB91F526KJDPMC		OFF	ON	
MB91F525KWDPMC		ON	ON	
MB91F525KJDPMC		OFF	ON	
MB91F524KWDPMC		ON	ON	
MB91F524KJDPMC		OFF	ON	
MB91F523KWDPMC		ON	ON	
MB91F523KJDPMC		OFF	ON	
MB91F522KWDPMC		ON	ON	
MB91F522KJDPMC		OFF	ON	LQS • 144 pin, (Lead pitch 0.5mm)
MB91F526KSDPMC	None	ON	ON	Plastic
MB91F526KHDPMC		OFF	ON	
MB91F525KSDPMC		ON	ON	
MB91F525KHDPMC		OFF	ON	
MB91F524KSDPMC		ON	ON	
MB91F524KHDPMC		OFF	ON	
MB91F523KSDPMC		ON	ON	
MB91F523KHDPMC		OFF	ON	
MB91F522KSDPMC		ON	ON	
MB91F522KHDPMC		OFF	ON	



### **■** Workaround

It is necessary to satisfy the below both conditions of (1) and (2).

- (1) Interrupt levels that are used as sources for recovering from the watch mode (power off) are '31', before CPU state changes to the watch mode (power off)
- (2) Don't use NMIX pin as source for recovering from the watch mode (power off)

## ■ Fix Status

Will not be planned

Document Number: 002-04662 Rev. \*D



Page	Section	Change Results							
		(Contin	-						
		Pin no.						Pin	
		64	80	100	120	144	176	Name	
								P025 WR1X <sup>*4, *5</sup>	
			_	4 *1	7 *1	10	12	SOT4_1	
								PPG25_0	
								TIN2_0	
			-		-	_	13	P172	
					_		10	PPG38_1	
								P026	
			4 *1	c *1	o *1	11	11	A00 *3, *4, *5	
			4	5 *1	8 *1	11	14	SCK4_1 PPG26_0	
								TIN3_0	
								P027	
								A01 *2, *3, *4, *5	
		4 *1	5 *1	6 *1	9 *1	12	15	SCS40_1	
		4	5		9	12	13	PPG27_0	
								TOT0_0	
								RTO3_1	
20	■PIN Description	-	-	-	-	-	16	P173	
20	ar in Description							PPG39_1 P030	
								A02 *4, *5	
		-	_	7 *1	10 *1	13	17	SCS41_1	
					_			PPG28_0	
								TOT1_0	
								P031	
			. *1	. *1	*1			A03 *3, *4, *5	
		-	6 <sup>*1</sup>	8 *1	11 *1	14	18	SCS42_1	
								PPG29_0 TOT2_0 <sup>*3</sup>	
								D032	
								A04 *2, *3, *4, *5	
		_ *1	_ *1	- *1	*1			SCS43_1	
		5 *1	7 *1	9 *1	12 *1	15	19	PPG30 0	
								TOT3_0	
								RTO2_1	
								P033	
								A05 *2, *3, *4, *5	
		a*1	0.*1	40*1	40*1	40		PPG31_0	
		6 *1	8 *1	10 *1	13 <sup>*1</sup>	16	20	ICU3_3	
								TIN4_0 RTO1_1	
								SCK3_2	



Page	Section		Change Results							
		A List o	f "Pin [	Descrip	tion" m	odified.				
		(Error)								
		(EIIOI)		Pin	no			Pin		
		64	80	100	120	144	176	Name		
		01	- 00	100	120		170	P047		
								A17		
		15	18	23	27	30	37	AN45		
			10	20	21		01	TRG8_0		
								TIN3_2		
								SOT0_1 P177		
			-	-	-	-	38	TRG11_0		
								P050		
					20	21	39	A18		
		-	-	-	28	31		TRG5_1		
								PPG33_0		
						20	40	P051		
			-	-	-	32	40	A19 TRG9 0		
								P052		
			-	-	-	33	41	A20		
	■PIN Description							PPG34_0		
23, 24								INT14_0		
	·							P053		
								A21 AN44		
		16	19	24	29	34	42	PPG35_0		
								INT14_1		
								SCK0_1		
								P054		
			-	-	-	35	43	SYSCLK		
								PPG36_0		
								P055 CS2X		
		-						SIN10_0		
		17	22	27	32	38	46	AN43		
								PPG37_0		
		<u> </u>						TIN4_1		
								P056		
								CS3X ICU9_0		
			_	_	33	39	49	PPG0_1		
					33	39		ICU0_1		
								TIN5_1		
								DTTI_2		



Page	Section	Change Results					
		A List of "Pin Description" modified.					
		(Error)					
		Function*2					
		General-purpose I/O port					
		External Bus chip select 3 output pin(0)					
		Input capture ch.9 input pin(0)					
		PPG ch.0 output pin(1)					
		Input capture ch.0 input pin(1)					
24	■PIN Description	Reload timer ch.5 event input pin(1)					
		Waveform generator ch.0 to ch.5 input pin(2)					
		(Correct)					
		Function <sup>*9</sup>					
		General-purpose I/O port					
		External Bus chip select 3 output pin					
		Input capture ch.9 input pin(0)					
		PPG ch.0 output pin(1)					
		Input capture ch.0 input pin(1)					
		Reload timer ch.5 event input pin(1)					
		Waveform generator ch.0 to ch.5 input pin(2)					



Page	Section		Change Results							
		A List o	A List of "Pin Description" modified.							
		(Error)								
				Pin						
		64	80	100	120	144	176	Name		
								P000		
								D16		
		-	-	94	111	131	159	SIN1_0		
								TIOA0_1 INT2_0		
								P001		
33	■PIN Description	-	75	95	112	132	160	D17		
								SOT1_0 TIOA1 1		
				<u>I</u>			<u>I</u>	110711_1		
		(Correct)								
			Pin no.					Pin		
		64	80	100	120	144	176	Name		
								P000		
								D16 *4, *5		
			-	94 *1	111 *1	131	159	SIN1 0		
								TIOA0_1 *4		
								INT2_0		
			*4	*4	*4			P001 D17 <sup>*3, *4, *5</sup>		
		-	75 <sup>*1</sup>	95 <sup>*1</sup>	112*1	132	160	SOT1_0 <sup>*3</sup>		
								TIOA1 1		



# Sales, Solutions, and Legal Information

## **Worldwide Sales and Design Support**

Cypress maintains a worldwide network of offices, solution centers, manufacturer's representatives, and distributors. To find the office closest to you, visit us at Cypress Locations.

**Products** 

ARM® Cortex® Microcontrollers cypress.com/arm

Automotive cypress.com/automotive

Clocks & Buffers cypress.com/clocks

Interface cypress.com/interface

Lighting & Power Control cypress.com/powerpsoc

Memory cypress.com/memory

PSoC cypress.com/psoc

Touch Sensing cypress.com/touch

USB Controllers cypress.com/usb

Wireless/RF cypress.com/wireless

**PSoC® Solutions** 

PSoC 1 | PSoC 3 | PSoC 4 | PSoC 5LP

**Cypress Developer Community** 

Community | Forums | Blogs | Video | Training | Components

Technical Support cypress.com/support

ARM and Cortex are the registered trademarks of ARM Limited in the EU and other countries

© Cypress Semiconductor Corporation, 2014-2016. This document is the property of Cypress Semiconductor Corporation and its subsidiaries, including Spansion LLC ("Cypress"). This document, including any software or firmware included or referenced in this document ("Software"), is owned by Cypress under the intellectual property laws and treaties of the United States and other countries worldwide. Cypress reserves all rights under such laws and treaties and does not, except as specifically stated in this paragraph, grant any license under its patents, copyrights, trademarks, or other intellectual property rights. If the Software is not accompanied by a license agreement and you do not otherwise have a written agreement with Cypress governing the use of the Software, then Cypress hereby grants you a personal, non-exclusive, nontransferable license (without the right to sublicense) (1) under its copyright rights in the Software (a) for Software provided in source code form, to modify and reproduce the Software solely for use with Cypress hardware products, only internally within your organization, and (b) to distribute the Software in binary code form externally to end users (either directly or indirectly through resellers and distributors), solely for use on Cypress hardware product units, and (2) under those claims of Cypress's patents that are infringed by the Software (as provided by Cypress, unmodified) to make, use, distribute, and import the Software solely for use with Cypress hardware products. Any other use, reproduction, modification, translation, or compilation of the Software is prohibited.

TO THE EXTENT PERMITTED BY APPLICABLE LAW, CYPRESS MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARD TO THIS DOCUMENT OR ANY SOFTWARE OR ACCOMPANYING HARDWARE, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE. To the extent permitted by applicable law, Cypress reserves the right to make changes to this document without further notice. Cypress does not assume any liability arising out of the application or use of any product or circuit described in this document. Any information provided in this document, including any sample design information or programming code, is provided only for reference purposes. It is the responsibility of the user of this document to properly design, program, and test the functionality and safety of any application made of this information and any resulting product. Cypress products are not designed, intended, or authorized for use as critical components in systems designed or intended for the operation of weapons, weapons systems, nuclear installations, life-support devices or systems, other medical devices or systems (including resuscitation equipment and surgical implants), pollution control or hazardous substances management, or other uses where the failure of the device or system could cause personal injury, death, or property damage ("Unintended Uses"). A critical component is any component of a device or system whose failure to perform can be reasonably expected to cause the failure of the device or system, or to affect its safety or effectiveness. Cypress is not liable, in whole or in part, and you shall and hereby do release Cypress from any claim, damage, or other liability arising from or related to all Unintended Uses of Cypress products. You shall indemnify and hold Cypress harmless from and against all claims, costs, damages, and other liabilities, including claims for personal injury or death, arising from or related to any Unintended Uses of Cypress products.

Cypress, the Cypress logo, Spansion, the Spansion logo, and combinations thereof, PSoC, CapSense, EZ-USB, F-RAM, and Traveo are trademarks or registered trademarks of Cypress in the United States and other countries. For a more complete list of Cypress trademarks, visit cypress.com. Other names and brands may be claimed as property of their respective owners.

Document Number: 002-04662 Rev. \*D June 23, 2016 Page 289 of 289